

PTC thermistors as limit temperature sensors

SMD, EIA case sizes 0402, 0603 and 0805, superior series

 Series/Type:
 B59421, B59641, B59721

 Date:
 March 2014

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EPCOS AG is a TDK Group Company.

Limit temperature sensors, EIA sizes 0402, 0603 and 0805

<u>SMD</u>

Applications

- Over-temperature protection of power components
- DC/DC converters
- SMPS
- Notebooks
- Home appliances
- Dimmers
- Electronic ballasts
- Automotive electronics
- Secondary protection of battery packs

Features

- Qualification based on AEC-Q200 rev. D
- Reflow soldering only
- Fast and reliable response
- RoHS-compatible
- UL approval to UL1434
- Certified in accordance with IEC 60738-1 and IEC 60730-1; Annex J15 and J17
- Lead-free terminations (tinned) for case sizes 0603 and 0805
- Lead-free ceramics for case sizes 0402 and 0805

Options

Other T_{sense} or resistance values on request

Delivery mode

- Blister tape (case size 0805) or cardboard tape (case sizes 0402 and 0603), 180-mm reel with 8-mm tape, taping to IEC 60286-3
- Packing unit: 10.000 pcs. (case size 0402), 4.000 pcs. (case size 0805 and 0603)

General technical data

Max. operating voltage		V _{max}	32	V DC
Minimum operating temperature	$(V \le V_{max})$	T _{min}	-40	°C
Maximum operating temperature	$(V \le V_{max})$	T_{max}	125 °C or T _{sense,1} +25 °C whichever is higher	°C



Superior series

Sensors

Limit temperature sensors, EIA sizes 0402, 0603 and 0805

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Electrical specifications and ordering codes

R _R	ΔR_{R}	T _{sense,1}	T _{sense,2}	Ordering code
$(V \le V_{max})$		(@ 4.7 kΩ)	(@ 47 kΩ)	_
Ω	%	°C	°C	
EIA case size	0402			
470	±50	75 ±5	-	B59421A0075A062
470	±50	85 ±5	-	B59421A0085A062
470	±50	95 ±5	-	B59421A0095A062
470	±50	105 ±5	-	B59421A0105A062
470	±50	115 ±5	-	B59421A0115A062
470	±50	125 ±5	-	B59421A0125A062
470	±50	135 ±5	-	B59421A0135A062
EIA case size	0603			
470	±50	75 ±5	90 ±7	B59641A0075A062
470	±50	85 ±5	100 ±7	B59641A0085A062
470	±50	95 ±5	110 ±7	B59641A0095A062
470	±50	105 ±5	120 ±7	B59641A0105A062
470	±50	115 ±5	130 ±7	B59641A0115A062
470	±50	125 ±5	140 ±7	B59641A0125A062
470	±50	135 ±5	150 ±7	B59641A0135A062
470	±50	145 ±5	-	B59641A0145A062

Note:

In order to limit self heating effects the electrical power during measurement should be below 2 mW for case size 0402 and below 4 mW for case size 0603.



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R _R	$\Delta {\rm R}_{\rm R}$	T _{sense,1}	R	R	R	Ordering code
$(V \le V_{max})$			(T _{sense,1} –5°C)	(T _{sense,1} +5°C)	(T _{sense,1} +15°C)	
Ω	%	°C	kΩ	kΩ	kΩ	
EIA case siz	ze 080)5				
680	±50	70	≤ 5.7	≥ 5.7	≥ 40 ¹⁾	B59721A0070A062
680	±50	80	≤ 5.7	≥ 5.7	$\geq 40^{1)}$	B59721A0080A062
680	±50	90	≤ 5.5	≥ 13.3	≥ 40	B59721A0090A062
680	±50	100	≤ 5.5	≥ 13.3	≥ 40	B59721A0100A062
680	±50	110	≤ 5.5	≥ 13.3	≥ 40	B59721A0110A062
680	±50	120	≤ 5.5	≥ 13.3	≥ 40	B59721A0120A062
680	±50	130	≤ 5.5	≥ 13.3	≥ 40	B59721A0130A062

Electrical specifications and ordering codes

Note:

In order to limit self heating effects the electrical power during measurement should be below 6 mW for case size 0805.

1) R (T_{sense,1} +25 °C)

Sensors

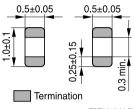
Limit temperature sensors, EIA sizes 0402, 0603 and 0805

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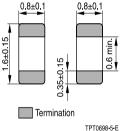
SMD

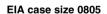
Dimensional drawings in mm

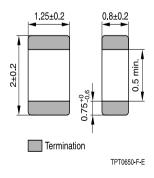
EIA case size 0402



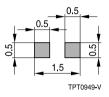
EIA case size 0603





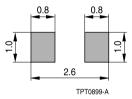


Solder pad



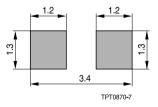
Recommended maximum dimensions (mm)

Solder pad



Recommended maximum dimensions (mm)





Recommended maximum dimensions (mm)

TPT0948-M-E

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Reliability data

Test	Standard	Test conditions	$ \Delta R_{25}/R_{25} $
Electrical endurance,	IEC 60738-1	Room temperature: I _{smax} , V _{max} ;	< 10%
cycling		Number of cycles: 100	
Electrical endurance,	IEC 60738-1	Storage at V _{max} /T _{op}	< 20%
constant		Test duration: 1000 h	
Damp heat	IEC 60738-1	Temperature of air: 40 °C	< 10%
		Relative humidity of air: 93%	
		Duration: 56 days	
		Test according to IEC 60068-2-78	
Rapid change	IEC 60738-1	$T_{LCT} = -40 \ ^{\circ}C, \ T_{UCT} = 125 \ ^{\circ}C$	< 10%
of temperature		Number of cycles: 5	
		Test duration: 30 min	
		Test according to IEC 60068-2-14, test Na	
Vibration I	IEC 60738-1	Frequency: 10 - 55 - 10 Hz	< 5%
		Displacement amplitude: 0.75 mm, resp.	
		Acceleration: 50 m/s ²	
		Test duration: 3×2 h	
		Test according to IEC 60028-2-6, test Fc	
Vibration II	MIL-STD-202,	Frequency: 10 2000 Hz	< 5%
	method 204	Displacement amplitude: 0.75 mm, resp.	
		Acceleration: 50 m/s ²	
		Test duration: 3×2 h	
		Test according to IEC 60028-2-6, test Fc	
Shock	IEC 60738-1	Pulse shape: half-sine	< 5%
		Acceleration: 390 m/s ²	
		Pulse duration: 6 ms; 6 x 4000 pulses	
		Test according to IEC 60068-2-27, test Ea	
Climatic sequence	IEC 60738-1	Dry heat: T _{UCT} = 125 °C	< 10%
		Test duration: 16 h	
		Damp heat first cycle	
		Cold: T _{LCT} = -40 °C	
		Test duration: 2 h	
		Damp heat 5 cycles	
		Tests performed according to	
		IEC 60068-2-30	
Bending test	IEC 60738-1	Components reflow-soldered to test board	< 5%
		Maximum bendig: 2 mm	
		Test according to IEC 60068-2-21, test Ue	
Adhesive strength on		Shearing of the component soldered on PCB	No
PCB		by a force of 5 N normal to components	visible
		longitudinal axis	damage

Please read *Cautions and warnings* and *Important notes* at the end of this document.



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Test	Standard	Test conditions	$ \Delta R_{25}/R_{25} $
Moisture resistance	AEC-Q200 /	Test Db2, category 25/125/56	< 10%
	IEC 60069-2-30		
Humidity	AEC-Q200 /	T = 80 °C; H = 85% r.H.; t = 1000 h	< 20%
	MIL-STD-202,	$V = 0.05 \cdot V_{max}$	
	method 103		
Thermal shock	AEC-Q200 /	$T_{LCT} = -55 \ ^{\circ}C,$	< 25%
	IEC 60738-1,	T _{UCT} = 125 °C	
	item 4.17	Number of cycles: 1000	
Resistance to	AEC-Q200 /	Soldering bath: 260 °C; t = 20 s	< 20%
soldering heat	IEC 60068-2-20,		
	test Tb		
ESD	AEC-Q200-002	150 pF/ 330 Ω; 8 kV contact discharge,	< 5%
		10 pulses in each polarity	
High temperature load		Soldered PTC to PCB @ 85 °C, load	< 20%
		maximum operating voltage for 1.5 h on and	
		0.5 h off. This cycle is repeated for	
		1000 ±12 h	

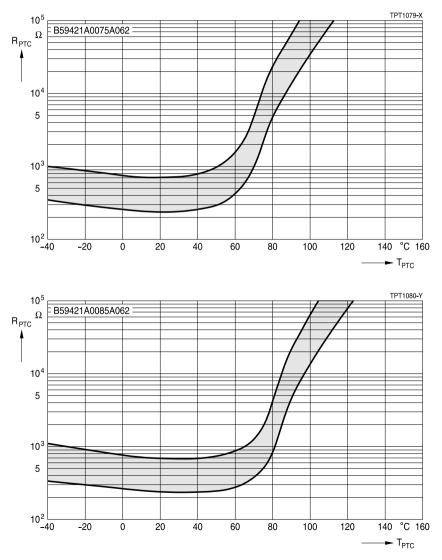
Sensors

Limit temperature sensors, EIA sizes 0402, 0603 and 0805

Superior series

<u>SMD</u>

Characteristics (typical) for case size 0402



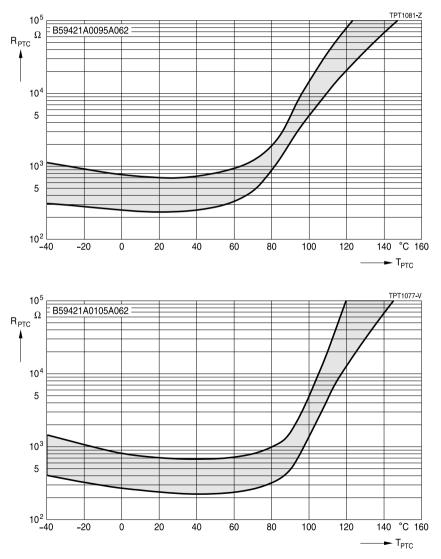
Sensors

Limit temperature sensors, EIA sizes 0402, 0603 and 0805

Superior series

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Characteristics (typical) for case size 0402



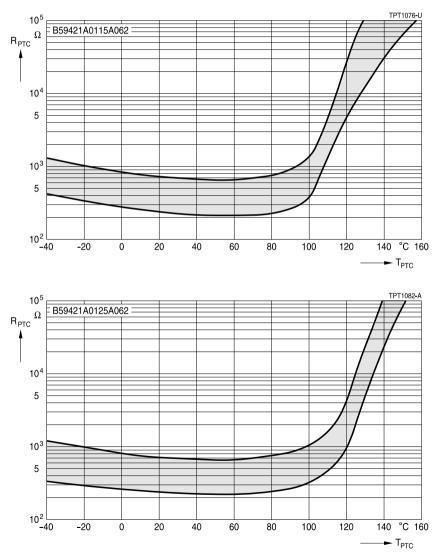
Sensors

Limit temperature sensors, EIA sizes 0402, 0603 and 0805

Superior series

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Characteristics (typical) for case size 0402



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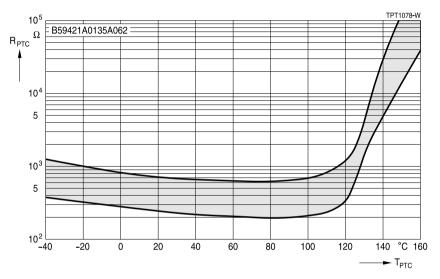
Sensors

Limit temperature sensors, EIA sizes 0402, 0603 and 0805

Superior series

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Characteristics (typical) for case size 0402



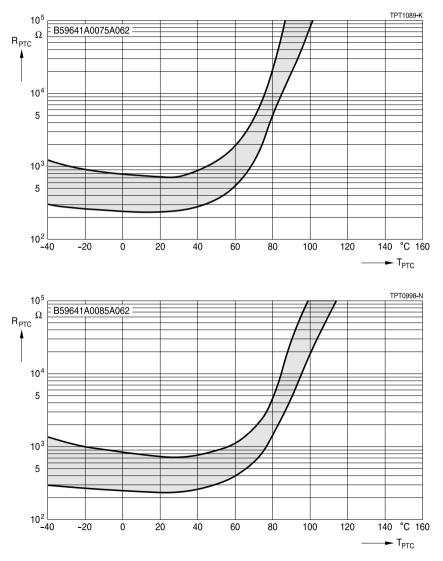
Sensors

Limit temperature sensors, EIA sizes 0402, 0603 and 0805

Superior series

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Characteristics (typical) for case size 0603



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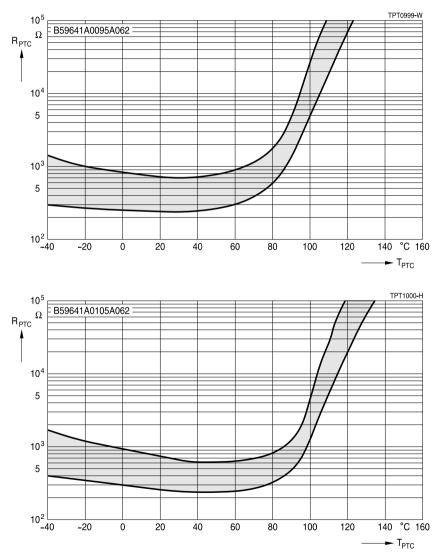
Sensors

Limit temperature sensors, EIA sizes 0402, 0603 and 0805

Superior series

<u>SMD</u>

Characteristics (typical) for case size 0603



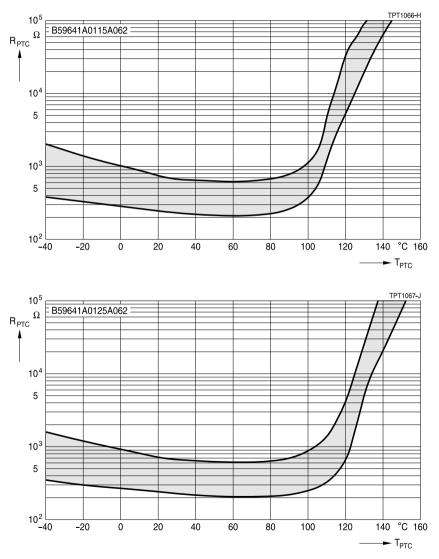
Sensors

Limit temperature sensors, EIA sizes 0402, 0603 and 0805

Superior series

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Characteristics (typical) for case size 0603



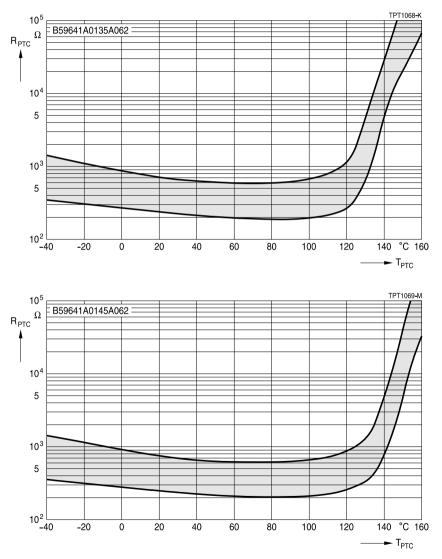
Sensors

Limit temperature sensors, EIA sizes 0402, 0603 and 0805

Superior series

<u>SMD</u>

Characteristics (typical) for case size 0603



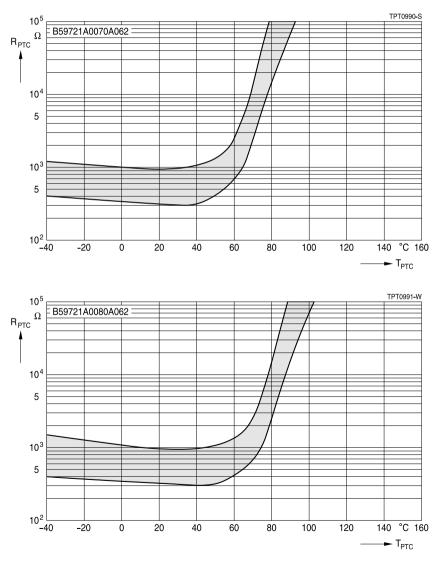


Limit temperature sensors, EIA sizes 0402, 0603 and 0805

Superior series

Characteristics (typical) for case size 0805

PTC resistance R_{PTC} versus PTC temperature T_{PTC} (measured at low signal voltage)



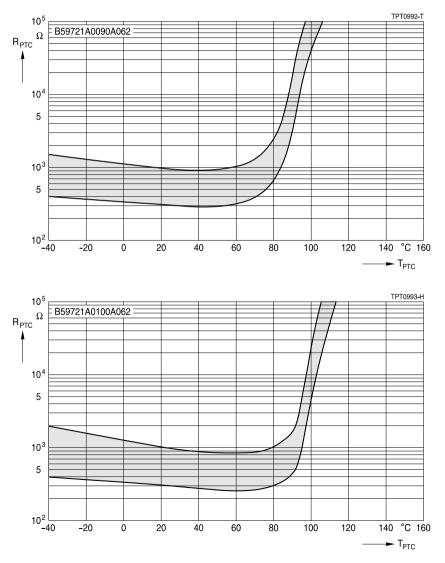
Please read *Cautions and warnings* and *Important notes* at the end of this document.



Limit temperature sensors, EIA sizes 0402, 0603 and 0805

Superior series

Characteristics (typical) for case size 0805

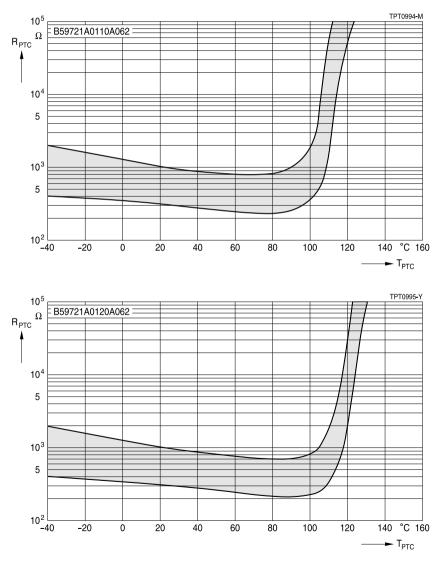




Limit temperature sensors, EIA sizes 0402, 0603 and 0805

Superior series

Characteristics (typical) for case size 0805

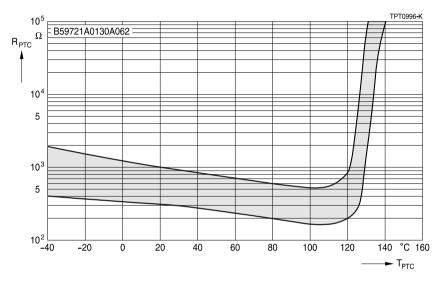




Limit temperature sensors, EIA sizes 0402, 0603 and 0805

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Characteristics (typical) for case size 0805





Limit temperature sensors, EIA sizes 0402, 0603 and 0805

Superior series

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Cautions and warnings

General

- EPCOS thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with EPCOS during the design-in-phase.
- Ensure suitability of thermistor through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

Storage

- Store thermistors only in original packaging. Do not open the package before storage.
- Storage conditions in original packaging: storage temperature -25 °C ... +45 °C, relative humidity ≤75% annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environment with effect on function on long-term operation (examples given under operation precautions).
- Use thermistor within the following period after delivery:
 - Through-hole devices (housed and leaded PTCs): 24 months
 - Motor protection sensors, glass-encapsulated sensors and probe assemblies: 24 months
 - Telecom pair and quattro protectors (TPP, TQP): 24 months
 - Leadless PTC thermistors for pressure contacting: 12 months
 - Leadless PTC thermistors for soldering: 6 months
 - SMDs in EIA sizes 3225 and 4032, and for PTCs with metal tags: 24 months
 - SMDs in EIA sizes 0402, 0603, 0805 and 1210: 12 months

Handling

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- Components must not be touched with bare hands. Gloves are recommended.
- Avoid contamination of thermistor surface during handling.

Soldering (where applicable)

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.
- Standard PTC heaters are not suitable for soldering.



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Mounting

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for assembly with thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in chapter "Mounting instructions", "Sealing and potting" must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum force of the clamping contacts pressing against the PTC must be 10 N.
- During operation, the thermistor's surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

Operation

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g. use VDR for limitation of overvoltage condition).

This listing does not claim to be complete, but merely reflects the experience of EPCOS AG.



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Symbols and terms

Symbol	Term
A	Area
С	Capacitance
C _{th}	Heat capacity
f	Frequency
I	Current
I _{max}	Maximum current
I _R	Rated current
I _{res}	Residual current
I _{PTC}	PTC current
l _r	Residual currrent
l _{r,oil}	Residual currrent in oil (for level sensors)
$I_{r,air}$	Residual currrent in air (for level sensors)
I _{RMS}	Root-mean-square value of current
Is	Switching current
I _{Smax}	Maximum switching current
LCT	Lower category temperature
Ν	Number (integer)
N _c	Operating cycles at V _{max} , charging of capacitor
N _f	Switching cycles at V _{max} , failure mode
Р	Power
P ₂₅	Maximum power at 25 °C
P _{el}	Electrical power
P_{diss}	Dissipation power
R _G	Generator internal resistance
R _{min}	Minimum resistance
R _R	Rated resistance
ΔR_R	Tolerance of R _R
R _P	Parallel resistance
R _{PTC}	PTC resistance
R _{ref}	Reference resistance
Rs	Series resistance
R ₂₅	Resistance at 25 °C
R _{25,match}	Resistance matching per reel/ packing unit at 25 °C
ΔR_{25}	Tolerance of R ₂₅
Т	Temperature
t	Time
T _A	Ambient temperature



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t _a	Thermal threshold time
T _c	Ferroelectric Curie temperature
t _E	Settling time (for level sensors)
T _R	Rated temperature
T_{sense}	Sensing temperature
T _{op}	Operating temperature
T _{PTC}	PTC temperature
t _R	Response time
T_{ref}	Reference temperature
T _{Rmin}	Temperature at minimum resistance
t _s	Switching time
T _{surf}	Surface temperature
UCT	Upper category temperature
V or V_{el}	Voltage (with subscript only for distinction from volume)
$V_{c(max)}$	Maximum DC charge voltage of the surge generator
$V_{\text{F,max}}$	Maximum voltage applied at fault conditions in protection mode
V _{RMS}	Root-mean-square value of voltage
V _{BD}	Breakdown voltage
V_{ins}	Insulation test voltage
$V_{\text{link,max}}$	Maximum link voltage
V _{max}	Maximum operating voltage
$V_{max,dyn}$	Maximum dynamic (short-time) operating voltage
V _{meas}	Measuring voltage
$V_{\text{meas,max}}$	Maximum measuring voltage
V _R	Rated voltage
V _{PTC}	Voltage drop across a PTC thermistor
α	Temperature coefficient
Δ	Tolerance, change
δ_{th}	Dissipation factor
$ au_{th}$	Thermal cooling time constant
λ	Failure rate
е	Lead spacing (in mm)

Abbreviations / Notes

SMD Surface-mount devices

- * To be replaced by a number in ordering codes, type designations etc.
- + To be replaced by a letter
- All dimensions are given in mm.

The commas used in numerical values denote decimal points.

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- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or lifesaving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
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